

Electronic Patent Application Fee Transmittal

Application Number:	10046739			
Filing Date:	17-Jan-2002			
Title of Invention:	THIN-FILM CRYSTAL WAFER HAVING PN JUNCTION AND METHOD FOR FABRICATING THE WAFER			
First Named Inventor/Applicant Name:	Hisashi Yamada			
Filer:	Andrew Duff Meikle/Linda Ruff			
Attorney Docket Number:	3885-0102P			
Filed as Large Entity				
Utility under 35 USC 111(a) Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Application for patent term adjustment	1455	1	200	200
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				200